

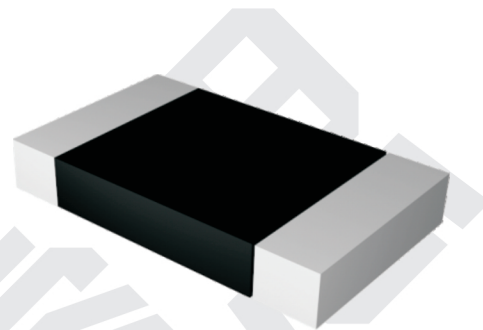
TCR $\leq \pm 25 \text{ ppm}/^\circ\text{C}$ (-55~125°C, +20°C Ref), Tightest tolerance $\pm 0.5\%$
Excellent long-term stability Low thermal EMF
AEC-Q200 qualified

Introduction

This series is made from a precision Nickel-Chrome alloy and which is then precisely machined and welded using exclusive EB-Welding equipment designed and manufactured independently by C&B Group. PCSK series is molded version which can achieve ultra-low TCR within $\pm 15 \text{ ppm}/^\circ\text{C}$ and high tolerance up to $\pm 0.1\%$. With an operating temperature range of -65°C to +170°C, the series is ideal for current sensing circuits which ask for high precision and low TCR at the same time. Visit www.resistor.today to check stock and more information.

Application

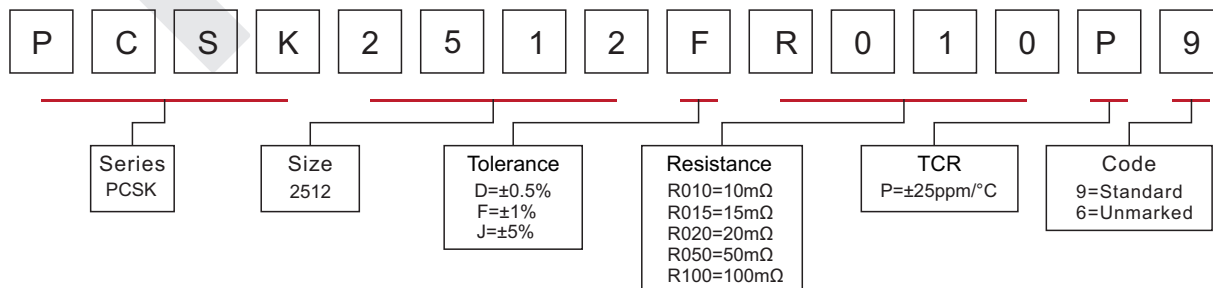
- Precision Instrument
- Semiconductor ATE
- Battery test equipment
- Precision power supply



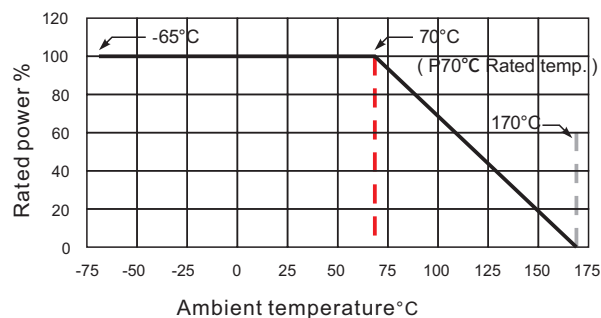
| Specifications (mm) | | | | | | | | |
|---------------------|---------|-------------|------------------|---------------------------------------|---|----------------|---------------|---------------------------|
| | | | | | | | | |
| Series | Size | Rated Power | Resistance range | Tolerance | TCR | Operating temp | Material | Packaging |
| PCSK | 2512 | 1W | 10mΩ~100mΩ | $\pm 0.5\%$ $\pm 1\%$ $\pm 5\%$ | $\leq \pm 25 \text{ ppm}/^\circ\text{C}$ (-55°C~+125°C, +20°C Ref) | -65°C~+170°C | Nickel-Chrome | tape&reel 4000pcs/reel |
| Dimensions | | | | | | | | |
| L | W | H | D | a | b | c | | |
| 6.40±0.2 | 3.2±0.2 | 0.8±0.1 | 0.8±0.2 | 3.6±0.1 | 3.6±0.1 | 2.0±0.1 | | |

Part Number Information

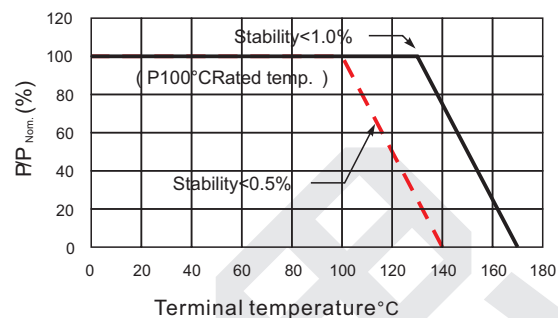
Example: PCSK2512BR010P9 (PCSK 2512 $\pm 1\%$ 10mΩ $\pm 25 \text{ ppm}/^\circ\text{C}$ Standard)



Derating curve(Ambient temp.)



Derating curve(Terminal temp.)



Performance

| Test Item | Test Method | Standard | Typical | Maximum |
|------------------------------|---|------------------------|-------------|---------|
| Short-time overload | 5x rated power for 5s, measured 24±2h after test | MIL-STD-202 Method 201 | ±0.1% | ±0.3% |
| High temp. storage | +170°C, 1000h, no load, measured 24±2h after test | MIL-STD-202 Method 108 | ±0.2% | ±0.5% |
| Moisture resistance | T=24h/cycle, no load, 7a and 7b not required, measured 24±2h after test | MIL-STD-202 Method 106 | ±0.02% | ±0.05% |
| Load life | +70°C, 2000h, rated power, measured 24±2h after test | MIL-STD-202 Method 108 | ±0.2% | ±0.5% |
| Resistance to soldering heat | +260°C±5°C, 10s±1s, measured 24±2h after test | MIL-STD-202 Method 210 | ±0.05% | ±0.3% |
| Thermal shock | -55°C~+125°C, 1000 cycles, measured 24±2h after test | JESD22 Method JA-104 | ±0.1% | ±0.5% |
| High temp. & high humidity | +85°C, 85%RH, 10% of rated power, 1000h, measured 24±2h after test | MIL-STD-202 Method 103 | ±0.05% | ±0.3% |
| Solderability | +235°C±5°C, 2s±0.5s | J-STD-202 | 95% covered | |

Popular Part Number

| Part Number | Size | Tolerance | Resistance | TCR |
|-----------------|------|-----------|------------|-----------|
| PCSK2512JR010P9 | 2512 | ±5% | 10mΩ | ±25ppm/°C |
| PCSK2512JR015P9 | 2512 | ±5% | 15mΩ | ±25ppm/°C |
| PCSK2512JR020P9 | 2512 | ±5% | 20mΩ | ±25ppm/°C |
| PCSK2512JR050P9 | 2512 | ±5% | 50mΩ | ±25ppm/°C |
| PCSK2512JR100P9 | 2512 | ±5% | 100mΩ | ±25ppm/°C |
| PCSK2512FR010P9 | 2512 | ±1% | 10mΩ | ±25ppm/°C |
| PCSK2512FR015P9 | 2512 | ±1% | 15mΩ | ±25ppm/°C |
| PCSK2512FR020P9 | 2512 | ±1% | 20mΩ | ±25ppm/°C |
| PCSK2512FR050P9 | 2512 | ±1% | 50mΩ | ±25ppm/°C |
| PCSK2512FR100P9 | 2512 | ±1% | 100mΩ | ±25ppm/°C |
| PCSK2512DR010P9 | 2512 | ±0.5% | 10mΩ | ±25ppm/°C |
| PCSK2512DR015P9 | 2512 | ±0.5% | 15mΩ | ±25ppm/°C |
| PCSK2512DR020P9 | 2512 | ±0.5% | 20mΩ | ±25ppm/°C |
| PCSK2512DR050P9 | 2512 | ±0.5% | 50mΩ | ±25ppm/°C |
| PCSK2512DR100P9 | 2512 | ±0.5% | 100mΩ | ±25ppm/°C |